- Can Be Used as a 4-Bit Digital Comparator
- Input Clamping Diodes Simplify System Design
- Fully Compatible with Most TTL Circuits

#### **FUNCTION TABLE**

INP	UTS	OUTPUT
Α	В	Y
L	L	н
L	н	L
н	L.	L
н	Н	н

H = high level, L = low level

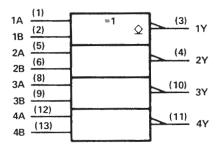
#### description

The 'LS266 is comprised of four independent 2-input exclusive-NOR gates with open-collector outputs. The open-collector outputs permit tying outputs together for multiple-bit comparisons.

#### logic symbol (each gate)



## logic symbol†



positive logic:  $Y = \overline{A \oplus B} = AB + \overline{AB}$ 

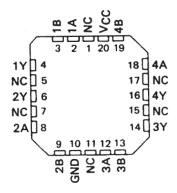
Pin numbers shown are for D, J, N, and W packages.

#### SN54LS266 . . . J OR W PACKAGE SN74LS266 . . . D OR N PACKAGE (TOP VIEW)

1A 1 U 14 VCC 1B 2 13 4B 1Y 3 12 4A

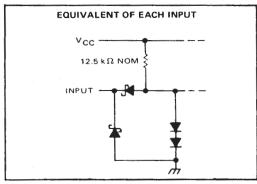
1Y | 3 | 12 | 4A 2Y | 4 | 11 | 4Y 2A | 5 | 10 | 3Y 2B | 6 | 9 | 3B GND | 7 | 8 | 3A

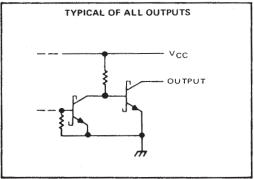
# SN54LS266 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

### schematic of inputs and outputs







 $<sup>^{\</sup>dagger}$  This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

# SN54LS266, SN74LS266 QUADRUPLE 2-INPUT EXCLUSIVE-NOR GATES WITH OPEN-COLLECTOR OUTPUTS

SDLS151 - DECEMBER 1972 - REVISED MARCH 1988

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)														7	٧
Input voltage														7	٧
Operating free-air temperature range:	SN54LS266		٠.								Ę	55°	C to	125	°C
	SN74LS266											0	°C	to 70'	°C
Storage temperature range														150	

NOTE 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

	SI	V54LS2	66	SI	UNIT		
	MIN	NOM	MAX	MIN	NOM	MAX	ONT
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	٧
High-level output voltage, VOH			5.5			5.5	٧
Low-level output current, IOL			4			8	mA
Operating free-air temperature, T <sub>A</sub>	-55		125	0		70	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		7507.004	SI	N54LS2	66	S	UNIT			
	PARAMETER	TEST CON	MIN	TYP <sup>‡</sup>	MAX	MIN	TYP‡	MAX	ONT	
VIH	High-level input voltage			2			2			٧
VIL	Low-level input voltage					0.7			0.8	V
VIK	Input clamp voltage	VCC = MIN,	I <sub>I</sub> = -18 mA			1.5			-1.5	٧
ЮН	High-level output current	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max,	V <sub>IH</sub> = 2 V, V <sub>OH</sub> = 5.5 V			100			100	μА
VOL	Low-level output voltage	V <sub>CC</sub> ≈ MIN, V <sub>IH</sub> = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	V
VOL	Low-rever output vortage	VIL = VIL max	I <sub>OL</sub> = 8 mA					0.35	0.5	
- la	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V1 = 7 V			0.2			0.2	mA
ЧН	High-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V			40			40	μА
IL	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			-0.8			-0.8	mA
Icc	Supply current	V <sub>CC</sub> = MAX,	See Note 2		8	13		8	13	mA

<sup>&</sup>lt;sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.  $^{\ddagger}$  All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{A} = 25 \text{ C}$ .

## switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER <sup>§</sup>	FROM (INPUT)	TEST CO	NDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	A or B	Other input low	CL = 15 pF,		18	30	ns
tPHL	7015	Other supur low	$R_L = 2 k\Omega$ ,		18	30	113
t <sub>PLH</sub>	A or B	Other input high	See Note 3		18	30	ns
tPHL	7, 0, 0	Other input high	00011010		18	30	

<sup>§</sup>tpLH = propagation delay time, low-to-high-level output



NOTE 2: 1<sub>CC</sub> is measured with one input of each gate at 4.5 V, the other inputs grounded, and the outputs open

tpHL = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.





28-Jul-2020

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	<b>Device Marking</b> (4/5)	Samples
SN54LS266J	ACTIVE	CDIP	J	14	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	SN54LS266J	Samples
SN74LS266D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS266	Samples
SN74LS266DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS266	Samples
SN74LS266N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS266N	Samples
SNJ54LS266J	ACTIVE	CDIP	J	14	1	TBD	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS266J	Samples
SNJ54LS266W	ACTIVE	CFP	W	14	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SNJ54LS266W	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



## PACKAGE OPTION ADDENDUM

28-Jul-2020

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LS266, SN74LS266:

Catalog: SN74LS266

Military: SN54LS266

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
  Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



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